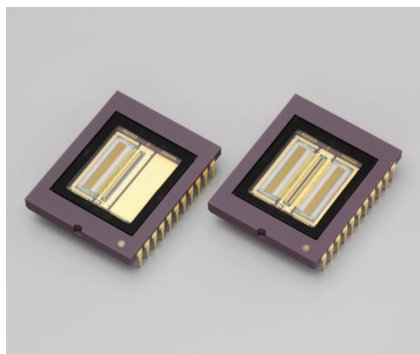


InGaAs linear image sensors



G11608 series

Wide spectral response range, near infrared image sensors (0.5 to 1.7 μm)

The G11608 series InGaAs linear image sensors are specifically designed for near infrared multichannel spectrophotometry. The G11608 series consists of an InGaAs photodiode array with enhanced sensitivity at shorter wavelengths, and CMOS chip that contains a charge amplifier array, a shift register, and a timing generator. The charge amplifier array is made up of CMOS transistors connected to each pixel of the InGaAs photodiode array. Signals from each pixel are read out in charge integration mode to achieve high sensitivity and stable operation.

The signal processing circuit on the CMOS chip offers two levels of conversion efficiency (CE) that can be selected by the external voltage to meet the application.

Features

- Wide spectral response range (0.5 to 1.7 μm)
- Low noise
- Two selectable conversion efficiencies
- Anti-saturation circuit
- CDS (correlated double sampling) circuit*1
- Built-in thermistor
- Simple operation (by built-in timing generator)*2
- High resolution: 25 μm pitch (G11608-512DA)

Applications

- Near infrared multichannel spectrophotometry
- Radiation thermometry
- Non-destructive inspection

*1: A major source of noise in charge amplifiers is the reset noise generated when the integration capacitance is reset. A CDS (correlated double sampling) circuit greatly reduces this reset noise by holding the signal immediately after reset to find the noise differential.

*2: Different signal timings must be properly set in order to operate a shift register. In conventional image sensor operation, external PLDs (programmable logic device) are used to input the required timing signals. However, the G11608 series image sensors internally generate all timing signals on the CMOS chip just by supplying CLK and RESET pulses. This makes it simple to set the timings.

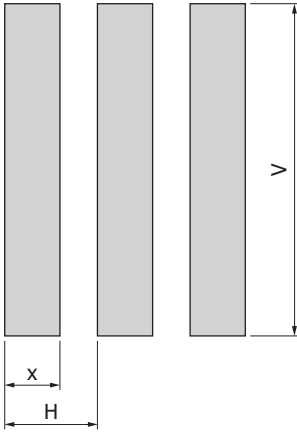
Selection guide

| Type no. | Cooling | Image area (mm) | Number of total pixels | Number of effective pixels | Applicable driver circuit |
|--------------|------------|-----------------|------------------------|----------------------------|---------------------------|
| G11608-256DA | Non-cooled | 12.8 × 0.50 | 256 | 256 | C11513-01 |
| G11608-512DA | | | 512 | 512 | |

Structure

| Type no. | Pixel size [μm (H) × μm (V)] | Pixel pitch (μm) | Package | Window material |
|--------------|---|-------------------------------|----------------|--|
| G11608-256DA | 50 × 500 | 50 | 22-pin ceramic | Borosilicate glass without anti-reflective coating |
| G11608-512DA | 25 × 500 | 25 | | |

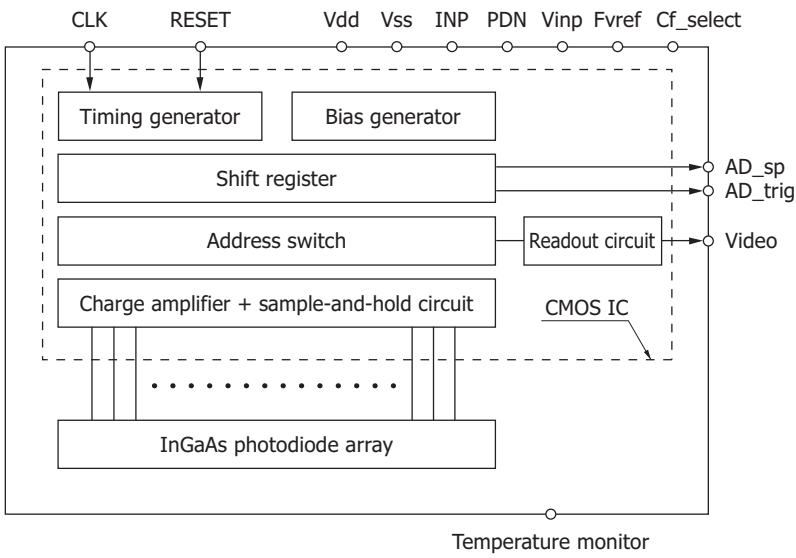
Details of photosensitive area (unit: μm)



| Number of pixels | x | H | V |
|------------------|----|----|-----|
| 256 | 30 | 50 | 500 |
| 512 | 10 | 25 | 500 |

KMIRC0057EA

Block diagram



KMIRC0058EA

➤ Absolute maximum ratings

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---------------------------------|------------------------------|----------------------|----------------------------|------|------|------|
| Supply voltage | Vdd, INP, Fvref Vinp, PDN | Ta=25 °C | -0.3 | - | +6 | V |
| Clock pulse voltage | Vφ | Ta=25 °C | -0.3 | - | +6 | V |
| Reset pulse voltage | V(RES) | Ta=25 °C | -0.3 | - | +6 | V |
| Gain selection terminal voltage | Vcfsel | Ta=25 °C | -0.3 | - | +6 | V |
| Operating temperature*3 | Topr | Non dew condensation | -10 | - | +60 | °C |
| Storage temperature*3 | Tstg | Non dew condensation | -20 | - | +70 | °C |
| Soldering conditions | - | | 260 °C or less, within 5 s | | | - |
| Thermistor power dissipation | Pth | | - | - | 400 | mW |

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

*3: When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

➤ Recommended terminal voltage (Ta=25 °C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | |
|---|--------|--------|------|------|------|---|
| Supply voltage | Vdd | 4.7 | 5.0 | 5.3 | V | |
| Differential reference voltage | Fvref | 1.1 | 1.2 | 1.3 | V | |
| Video line reset voltage | Vinp | 3.9 | 4.0 | 4.1 | V | |
| Input stage amplifier reference voltage | INP | 3.9 | 4.0 | 4.1 | V | |
| Photodiode cathode voltage | PDN | 3.9 | 4.0 | 4.1 | V | |
| Ground | GND | - | 0 | - | V | |
| Clock pulse voltage | High | Vφ | 4.7 | 5.0 | 5.3 | V |
| | Low | | 0 | 0 | 0.4 | |
| Reset pulse voltage | High | V(RES) | 4.7 | 5.0 | 5.3 | V |
| | Low | | 0 | 0 | 0.3 | |

➤ Electrical characteristics (Ta=25 °C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | |
|------------------------------|------------------------------|------------|-------|----------|-----------|----|
| Consumption current | G11608-512DA G11608-256DA | I(Vdd) | - | 45 85 | 80 120 | mA |
| | | Ifvref | - | - | 1 | |
| | | Ivinp | - | - | 1 | |
| | | Iinp | - | - | 1 | |
| | | Ipdn | - | - | 1 | |
| Operation frequency | fop | 0.1 | 1 | 5 | MHz | |
| Video data rate | DR | 0.1 | f | 5 | MHz | |
| Video output voltage | High | VH | - | 4.0 | - | V |
| | Low | | VL | - | 1.2 | - |
| Output offset voltage | Vos | - | Fvref | - | V | |
| Output impedance | Zo | - | 5 | - | kΩ | |
| AD_trig, AD_sp pulse voltage | High | Vtrig, Vsp | - | Vdd | - | V |
| | Low | | GND | - | - | |
| Thermistor resistance | Rth | 9.0 | 10.0 | 11.0 | kΩ | |
| Thermistor B constant*4 | B | - | 3950 | - | K | |

*4: T₁=25 °C, T₂=50 °C

Electrical and optical characteristics (Ta=25 °C, Vdd=5 V, INP=Vin=PDN=4 V, Fvref=1.2 V, Vφ=5 V, f=1 MHz)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit | |
|---|--------------|--------------------------|-------------------------|------------|-------|-------------------|-----|
| Spectral response range | λ | | - | 0.5 to 1.7 | - | μm | |
| Peak sensitivity wavelength | λ_p | | - | 1.55 | - | μm | |
| Photo sensitivity | S | $\lambda=\lambda_p$ | 0.8 | 1.0 | - | A/W | |
| Conversion efficiency*5 | CE | Cf=10 pF | - | 16 | - | nV/e ⁻ | |
| | | Cf=1 pF | - | 160 | - | | |
| Photoresponse nonuniformity*6 | PRNU | | - | ±3 | ±5 | % | |
| Saturation charge | Qsat | CE=16 nV/e ⁻ | 168 | 175 | - | Me ⁻ | |
| | | CE=160 nV/e ⁻ | 16.8 | 17.5 | - | | |
| Saturation voltage | Vsat | | 2.7 | 2.8 | - | V | |
| Dark output | G11608-256DA | V _D | CE=16 nV/e ⁻ | -1 | ±0.1 | 1 | V/s |
| | G11608-512DA | | | -0.5 | ±0.05 | 0.5 | |
| Dark current | G11608-256DA | I _D | CE=16 nV/e ⁻ | -10 | ±1 | 10 | pA |
| | G11608-512DA | | | -5 | ±0.5 | 5 | |
| Temperature coefficient of dark output (dark current) | - | CE=16 nV/e ⁻ | - | 1.1 | - | times/°C | |
| Readout noise*7 | N | CE=16 nV/e ⁻ | - | 200 | 400 | μVrms | |
| | | CE=160 nV/e ⁻ | - | 300 | 500 | | |
| Dynamic range | D | CE=16 nV/e ⁻ | 6750 | 14000 | - | - | |
| Defective pixels*8 | - | CE=16 nV/e ⁻ | - | - | 1 | % | |

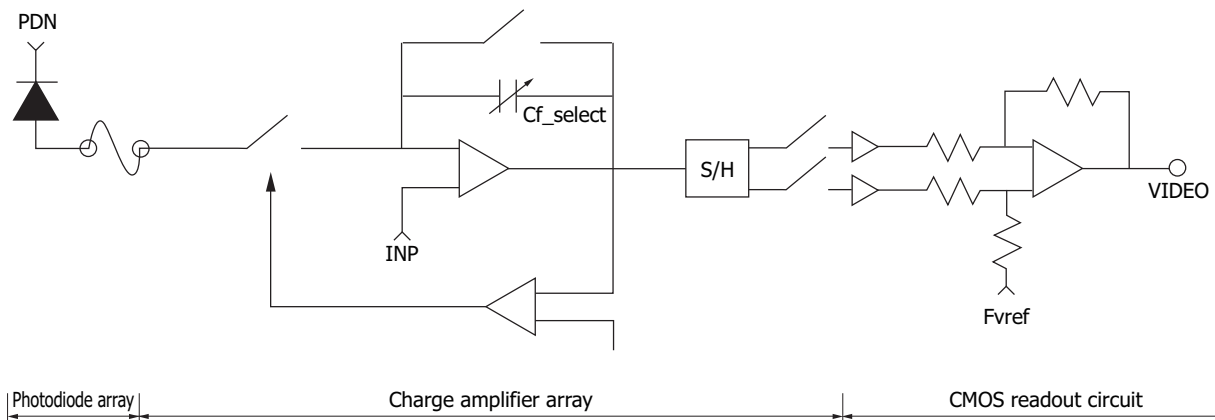
*5: Refer to pin connection when changing conversion efficiency.

*6: 50% of saturation, integration time 10 ms, after dark output subtraction, excluding first and last pixels

*7: Integration time=10 ms (CE=16nV/e⁻), 1 ms (CE=160 nV/e⁻)

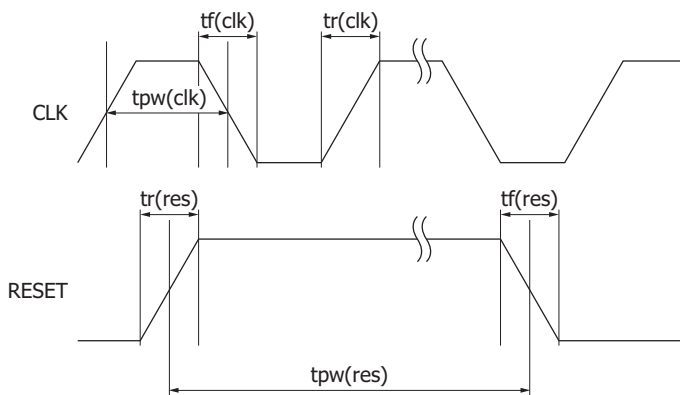
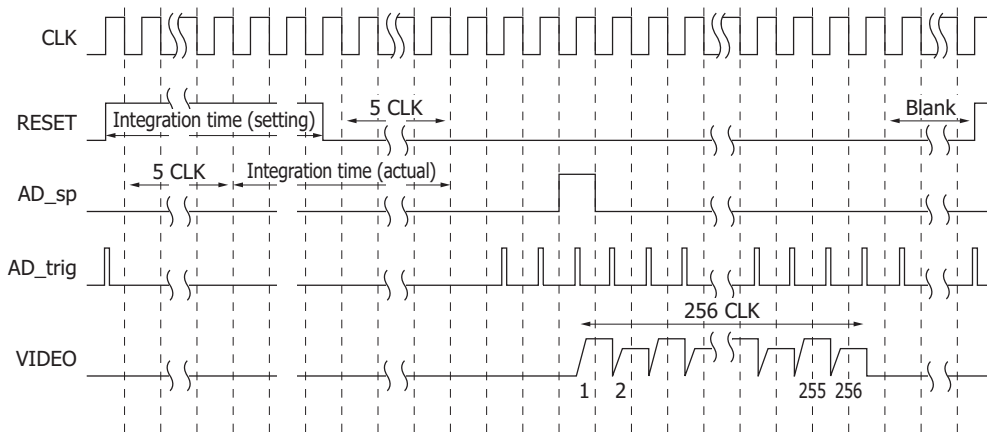
*8: Pixels with photoresponse nonuniformity, readout noise, or dark current higher than the maximum value

Equivalent circuit



KM1RC0049EA

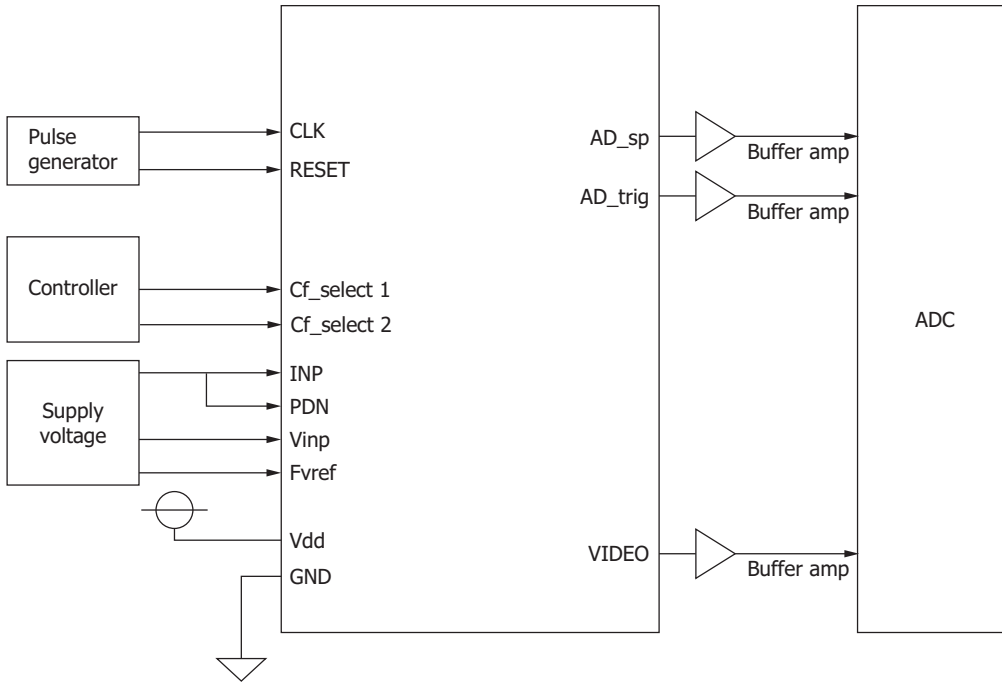
Timing chart (each video line)



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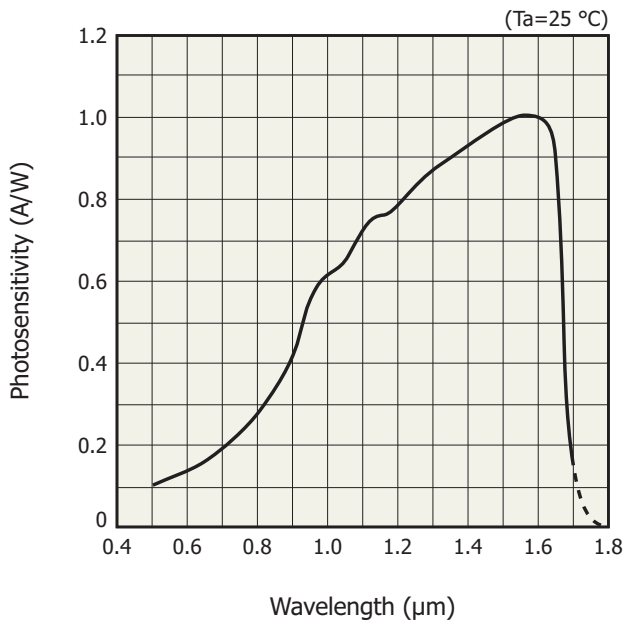
| Parameter | Symbol | Min. | Typ. | Max. | Unit | |
|-----------------------------|--------------------|------------|------|------|------|--------|
| Clock pulse width | $tpw(clk)$ | 60 | 500 | 5000 | ns | |
| Clock pulse rise/fall times | $tr(clk), tf(clk)$ | 0 | 20 | 30 | ns | |
| Reset pulse width | High Low | $tpw(res)$ | 6 | - | - | clocks |
| | | | 284 | - | - | |
| Reset pulse rise/fall times | $tr(res), tf(res)$ | 0 | 20 | 30 | ns | |

Connection example



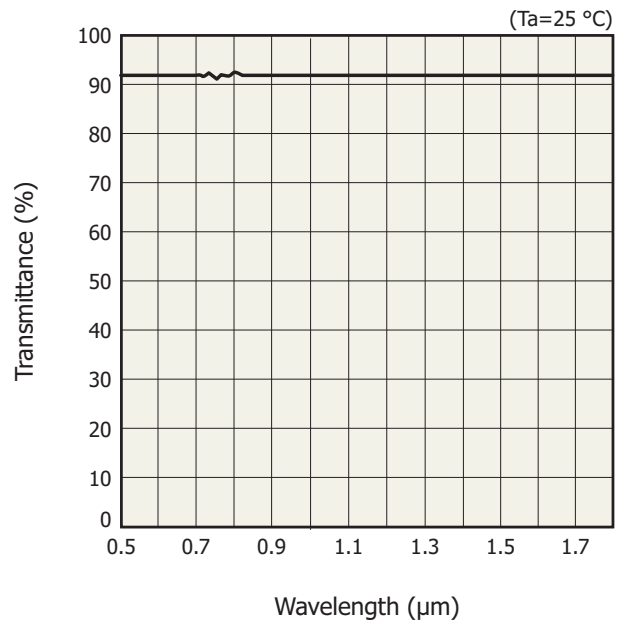
KMIRC0056EB

Spectral response (typical example)



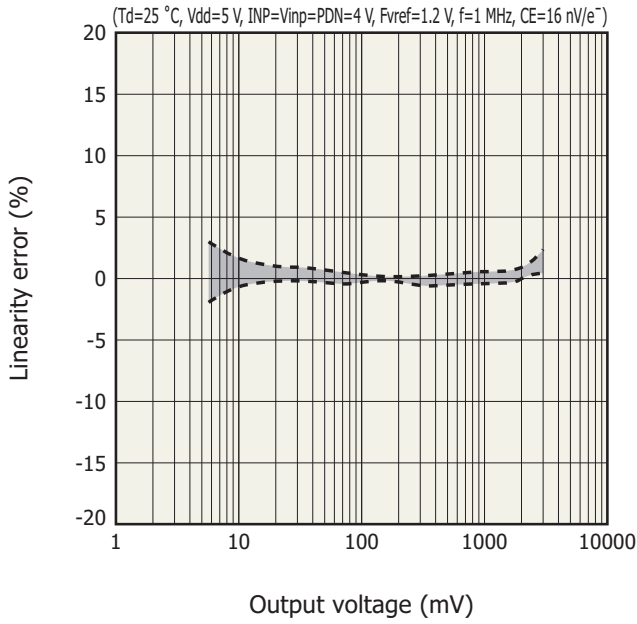
KMIRB0057EC

Spectral transmittance characteristic of window material (typical example)

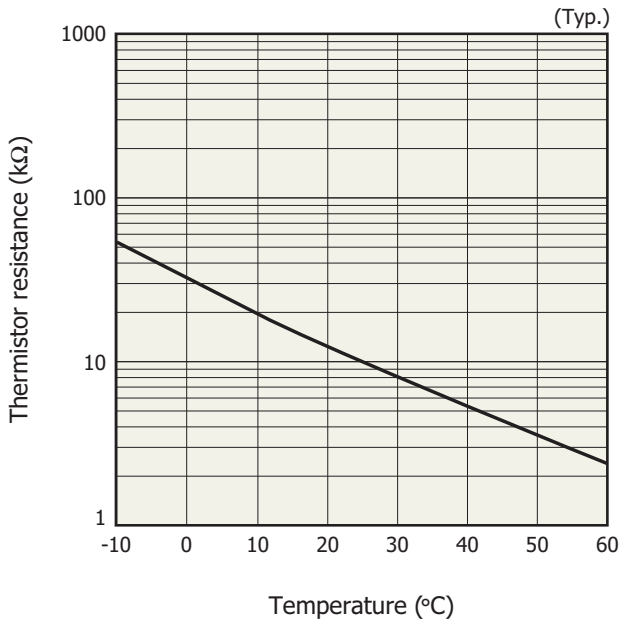


KMIRB0058EA

Linearity error



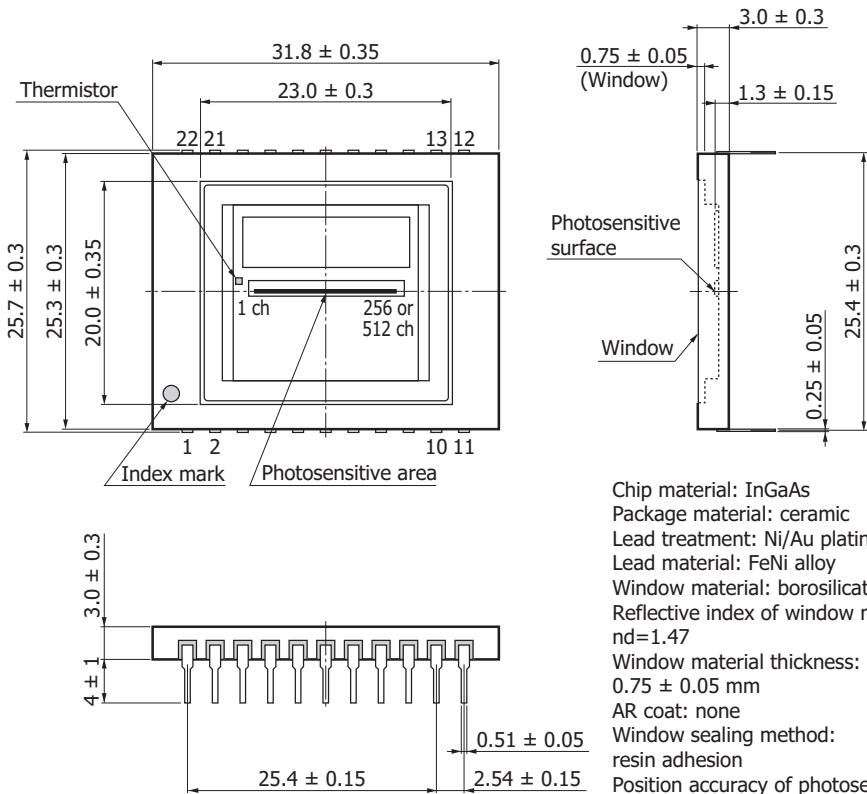
Temperature characteristics of thermistor



| Temperature (°C) | Thermistor resistance (kΩ) |
|------------------|----------------------------|
| -10 | 53.0 |
| -5 | 41.2 |
| 0 | 32.1 |
| 5 | 25.1 |
| 10 | 19.8 |
| 15 | 15.7 |
| 20 | 12.5 |
| 25 | 10.0 |
| 30 | 8.06 |
| 35 | 6.53 |
| 40 | 5.32 |
| 45 | 4.36 |
| 50 | 3.59 |
| 55 | 2.97 |
| 60 | 2.47 |

KMIRB0059EA

Dimensional outline (unit: mm)



Chip material: InGaAs
 Package material: ceramic
 Lead treatment: Ni/Au plating
 Lead material: FeNi alloy
 Window material: borosilicate glass
 Reflective index of window material:
 $n_d=1.47$
 Window material thickness:
 0.75 ± 0.05 mm
 AR coat: none
 Window sealing method:
 resin adhesion
 Position accuracy of photosensitive area center:
 ± 0.3 (with respect to package center)
 Rotation accuracy of photosensitive area:
 $\pm 5^\circ$ (with respect to package center)

| Pin no. | G11608-256DA | G11608-512DA |
|---------|--------------|--------------|
| 1 | NC | AD_sp_EVEN |
| 2 | NC | RESET_EVEN |
| 3 | NC | AD_trig_EVEN |
| 4 | NC | NC |
| 5 | Cf_select2 | Cf_select2 |
| 6 | Cf_select1 | Cf_select1 |
| 7 | Thermistor | Thermistor |
| 8 | Thermistor | Thermistor |
| 9 | NC | CLK_EVEN |
| 10 | Fvref | Fvref |
| 11 | NC | VIDEO_EVEN |
| 12 | VIDEO | VIDEO_ODD |
| 13 | Vinp | Vinp |
| 14 | CLK | CLK_ODD |
| 15 | PDN* | PDN* |
| 16 | INP* | INP* |
| 17 | GND | GND |
| 18 | Vdd | Vdd |
| 19 | NC | NC |
| 20 | AD_trig | AD_trig_ODD |
| 21 | RESET | RESET_ODD |
| 22 | AD_sp | AD_sp_ODD |

* PDN and INP should be at the same potential.
 It is recommended to use the same power source and short between their pins

KMIRA0024EB

Pin connections

| Terminal name | Input/Output | Function and recommended connection | Remark |
|---------------|--------------|---|--------------|
| PDN | Input | Cathode bias terminal for InGaAs photodiode. This should be at the same potential as INP. | 4.0 V |
| AD_sp | Output | Digital start signal for A/D conversion | 0 to 5 V |
| Cf_select1, 2 | Input**8 | Signal for selecting feedback capacitance (integration capacitance) on CMOS chip | 0 V or 5 V |
| Thermistor | Output | Thermistor for monitoring temperature inside the package | - |
| AD_trig | Output | Sampling synchronous signal for A/D conversion | 0 to 5 V |
| RESET | Input | Reset pulse for initializing the feedback capacitance in the charge amplifier formed in the CMOS chip. Integration time is determined by the high period of this pulse. | 0 to 5 V |
| CLK | Input | Clock pulse for operating the CMOS shift register | 0 to 5 V |
| INP | Input | Input stage amplifier reference voltage. Supply voltage for operating the signal processing circuit in the CMOS chip. This should be at the same potential as PDN. | 4.0 V |
| Vinp | Input | Video line reset voltage. Supply voltage for operating the signal processing circuit in the CMOS chip. | 4.0 V |
| Fvref | Input | Differential amplifier reference voltage. Supply voltage for operating the signal processing circuit in the CMOS chip. | 1.2 V |
| VIDEO | Output | Differential amplifier output. Analog video signal. | 1.2 to 3.0 V |
| Vdd | Input | Supply voltage for operating the signal processing circuit in the CMOS chip (+5 V) | 5 V |
| GND | Input | Grand for the signal processing circuit in the CMOS chip (0 V) | 0 V |

**8: Conversion efficiency is determined by supply voltage to the Cf_select terminals as shown below.

| Conversion efficiency | Cf_select1 | Cf_select2 |
|---------------------------------|------------|------------|
| 16 nV/e ⁻ (Cf=10 pF) | High | High |
| 160 nV/e ⁻ (Cf=1 pF) | High | Low |

Low: 0 V (GND), High: 5 V (Vdd)

Electrostatic countermeasures

This device has a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools to prevent static discharges. Also protect this device from surge voltages which might be caused by peripheral equipment.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

■ Precautions

- Disclaimer
- Image sensors

Information described in this material is current as of March, 2016.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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